# 4 x 4 Register File with 3-State Outputs

The TTL/MSI SN74LS670 is a high-speed, low-power 4 x 4 Register File organized as four words by four bits. Separate read and write inputs, both address and enable, allow simultaneous read and write operation.

The 3-state outputs make it possible to connect up to 128 outputs to increase the word capacity up to 512 words. Any number of these devices can be operated in parallel to generate an n-bit length.

- Simultaneous Read/Write Operation
- Expandable to 512 Words by n-Bits
- Typical Access Time to 20 ns
- 3-State Outputs for Expansion
- Typical Power Dissipation of 125 mW

#### **GUARANTEED OPERATING RANGES**

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	4.75	5.0	5.25	V
T <sub>A</sub>	Operating Ambient Temperature Range	0	25	70	°C
I <sub>OH</sub>	Output Current – High			-2.6	mA
I <sub>OL</sub>	Output Current – Low			24	mA



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# LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 648



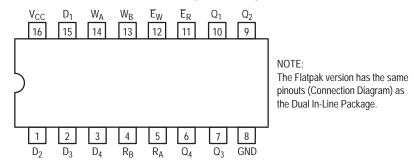
SOIC D SUFFIX CASE 751B

#### **ORDERING INFORMATION**

Device	Package	Shipping		
SN74LS670N	16 Pin DIP	2000 Units/Box		
SN74LS670D	16 Pin	2500/Tape & Reel		

1

# CONNECTION DIAGRAM DIP (TOP VIEW)

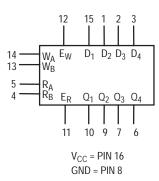


		LOADING (Note a)	
PIN NAMES		HIGH	LOW
D <sub>1</sub> – D <sub>4</sub>	Data Inputs	0.5 U.L.	0.25 U.L.
W <sub>A</sub> , W <sub>B</sub>	Write Address Inputs	0.5 U.L.	0.25 U.L.
$\overline{E}_W$	Write Enable (Active LOW) Input	1.0 U.L.	0.5 U.L.
$R_A$ , $R_B$	Read Address Inputs	0.5 U.L.	0.25 U.L.
E <sub>R</sub>	Read Enable (Active LOW) Input	1.5 U.L.	0.75 U.L.
Q <sub>1</sub> – Q <sub>4</sub>	Outputs	65 U.L.	15 U.L.

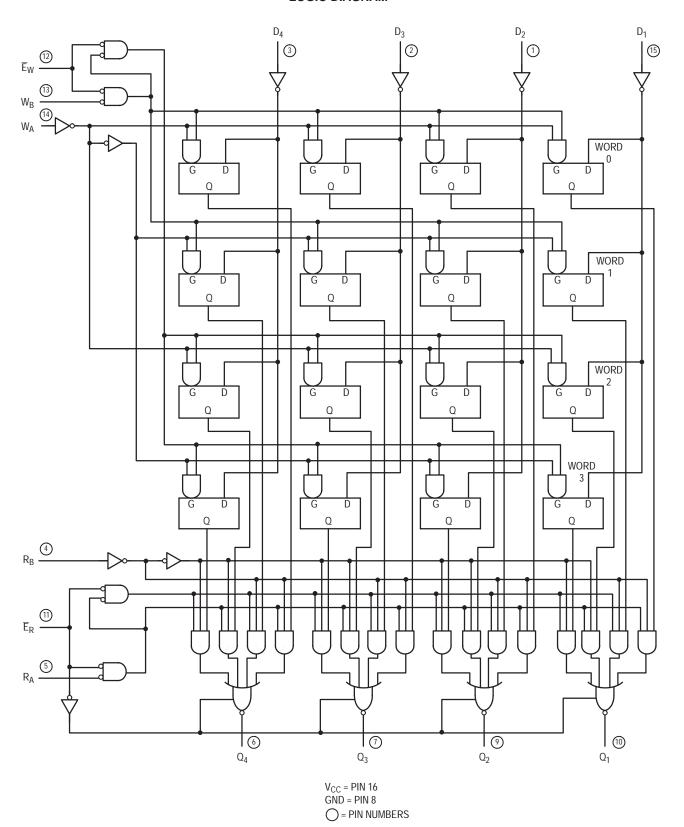
#### NOTES:

a) 1 TTL Unit Load (U.L.) = 40  $\mu$ A HIGH/1.6 mA LOW.

# LOGIC SYMBOL



# LOGIC DIAGRAM



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# DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
V <sub>IH</sub>	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V <sub>IL</sub>	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
V <sub>IK</sub>	Input Clamp Diode Voltage		-0.65	-1.5	V	V <sub>CC</sub> = MIN, I <sub>IN</sub> =	–18 mA
V <sub>OH</sub>	Output HIGH Voltage	2.4	3.1		V	$V_{CC}$ = MIN, $I_{OH}$ = MAX, $V_{IN}$ = $V_{IH}$ or $V_{IL}$ per Truth Table	
.,	0 / / 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0		0.25	0.4	V	I <sub>OL</sub> = 12 mA	$V_{CC} = V_{CC} MIN,$
$V_{OL}$	Output LOW Voltage		0.35	0.5	V	I <sub>OL</sub> = 24 mA	<ul> <li>V<sub>IN</sub> = V<sub>IL</sub> or V<sub>IH</sub></li> <li>per Truth Table</li> </ul>
I <sub>OZH</sub>	Output Off Current HIGH			20	μА	V <sub>CC</sub> = MAX, V <sub>O</sub> = 2.7 V	
I <sub>OZL</sub>	Output Off Current LOW			-20	μΑ	$V_{CC} = MAX, V_O = 0.4 V$	
I <sub>IH</sub>	Input HIGH Current D, R, W E <sub>W</sub> E <sub>R</sub>			20 40 60	μА	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 2.7 V	
	D, R, W E <sub>W</sub> E <sub>R</sub>			0.1 0.2 0.3	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 7.0 V	
I <sub>IL</sub>	Input LOW Current D, R, W E <sub>W</sub> E <sub>R</sub>			-0.4 -0.8 -1.2	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 0.4 V	
Ios	Short Circuit Current (Note 1)	-30		-130	mA	V <sub>CC</sub> = MAX	
I <sub>CC</sub>	Power Supply Current			50	mA	V <sub>CC</sub> = MAX	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

# AC CHARACTERISTICS $(T_A = 25^{\circ}C)$

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay, R <sub>A</sub> or R <sub>B</sub> to Output		23 25	40 45	ns		
t <sub>PLH</sub>	Propagation Delay, $\overline{E}_W$ to Output		26 28	45 50	ns	V <sub>CC</sub> = 5.0 V, C <sub>L</sub> = 45 pF	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay, Data to Output		25 23	45 40	ns		
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time		15 22	35 40	ns		
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time		16 30	35 50	ns	C <sub>L</sub> = 5.0 pF	

# AC SETUP REQUIREMENTS $(T_A = 25^{\circ}C)$

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
t <sub>W</sub>	Pulse Width	25			ns		
t <sub>s</sub>	Setup Time, (D)	10			ns		
t <sub>s</sub>	Setup Time, (W)	15			ns	V 50V	
t <sub>h</sub>	Hold Time, (D)	15			ns	V <sub>CC</sub> = 5.0 V	
t <sub>h</sub>	Hold Time, (W)	5.0			ns		
t <sub>rec</sub>	Recovery Time	25			ns		

# **AC WAVEFORMS**

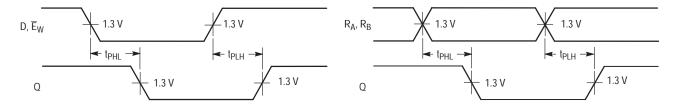


Figure 2. Figure 1.

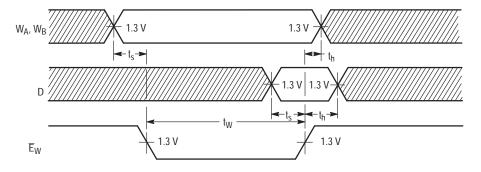
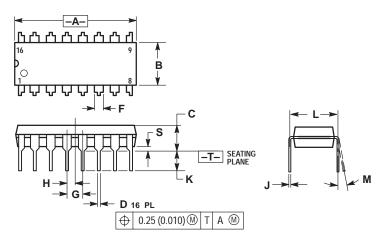


Figure 3.

# **PACKAGE DIMENSIONS**

## **N SUFFIX** PLASTIC PACKAGE CASE 648-08 ISSUE R

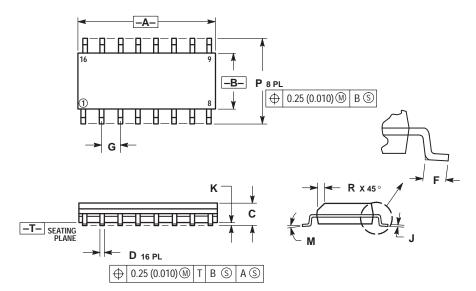


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS			
DIM	MIN	MAX	MIN	MAX			
Α	0.740	0.770	18.80	19.55			
В	0.250	0.270	6.35	6.85			
С	0.145	0.175	3.69	4.44			
D	0.015	0.021	0.39	0.53			
F	0.040	0.70	1.02	1.77			
G	0.100	BSC	2.54	BSC			
Н	0.050	BSC	1.27	BSC			
J	0.008	0.015	0.21	0.38			
K	0.110	0.130	2.80	3.30			
L	0.295	0.305	7.50	7.74			
M	0°	10 °	0°	10 °			
S	0.020	0.040	0.51	1.01			

# **PACKAGE DIMENSIONS**

## **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751B-05 **ISSUE J**



#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES					
DIM	MIN	MAX	MIN	MAX				
Α	9.80	10.00	0.386	0.393				
В	3.80	4.00	0.150	0.157				
С	1.35	1.75	0.054	0.068				
D	0.35	0.49	0.014	0.019				
F	0.40	1.25	0.016	0.049				
G	1.27	BSC	0.050	BSC				
J	0.19	0.25	0.008	0.009				
K	0.10	0.25	0.004	0.009				
M	0 °	7°	0 °	7°				
Р	5.80	6.20	0.229	0.244				
R	0.25	0.50	0.010	0.019				

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Email: ONlit-asia@hibbertco.com

**JAPAN**: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–8549

**Phone**: 81–3–5487–8345 **Email**: r14153@onsemi.com

Fax Response Line: 303-675-2167

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